

ICE15N60

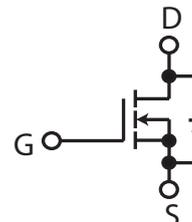
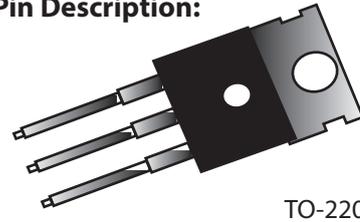
N-Channel Enhancement Mode MOSFET

Features:

- Low $r_{DS(on)}$
- Ultra Low Gate Charge
- High dv/dt Capability
- High Unclamped Inductive Switching (UIS) Capability
- High Peak Current Capability
- Increased Transconductance Performance
- Optimized Design For High Performance Power Systems

| Product Summary | | | |
|-----------------|--------------------------|---------------|-----|
| I_D | $T_A = 25^\circ\text{C}$ | 15A | Max |
| $V_{(BR)DSS}$ | $I_D = 250\mu\text{A}$ | 600V | Min |
| $r_{DS(ON)}$ | $V_{GS} = 10\text{V}$ | 0.23 Ω | Typ |
| Q_g | $V_{DS} = 480\text{V}$ | 59nC | Typ |

Pin Description:



Maximum Ratings @ $T_j = 25^\circ\text{C}$, Unless Otherwise Specified

| Symbol | Parameter | Value | Unit | Conditions |
|-----------------------|-----------------------------------|-------------|------------------|---|
| I_D | Continuous Drain Current | 15 | A | $T_C = 25^\circ\text{C}$ |
| $I_{D, \text{pulse}}$ | Pulsed Drain Current | 45 | A | $T_C = 25^\circ\text{C}$ |
| E_{AS} | Avalanche Energy, Single Pulse | 460 | mJ | $I_D = 7.5\text{A}$ |
| I_{AR} | Avalanche Current, Repetitive | 7.5 | A | Limited by $T_{j,max}$ |
| dv/dt | MOSFET dv/dt Ruggedness | 50 | V/ns | $V_{DS} = 480\text{V}, I_D = 15\text{A}, T_j = 125^\circ\text{C}$ |
| V_{GS} | Gate Source Voltage | ± 20 | V | Static |
| | | ± 30 | | AC (f>Hz) |
| P_{tot} | Power Dissipation | 160 | W | $T_C = 25^\circ\text{C}$ |
| T_j, T_{stg} | Operating and Storage Temperature | -55 to +150 | $^\circ\text{C}$ | |
| | Mounting Torque | 60 | Ncm | M 3 & 3.5 screws |

| Symbol | Parameter | Values | | | Unit | Conditions |
|--------|-----------|--------|-----|-----|------|------------|
| | | Min | Typ | Max | | |

Thermal Characteristics

| | | | | | | |
|------------|---|---|---|-----|--------------------|------------------------------------|
| R_{thJC} | Thermal Resistance, Junction to Case | - | - | 0.8 | $^\circ\text{C/W}$ | Leaded |
| R_{thJA} | Thermal Resistance, Junction to Ambient | - | - | 62 | | |
| T_{sold} | Soldering Temperature, Wave Soldering Only Allowed At Leads | - | - | 260 | $^\circ\text{C}$ | 1.6mm (0.063in.) from Case for 10s |

Electrical Characteristics @ $T_j = 25^\circ\text{C}$, Unless Otherwise Specified

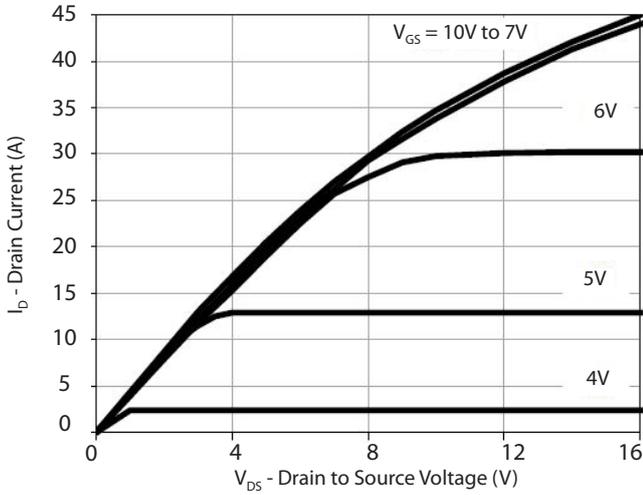
| Static Characteristics | | | | | | |
|------------------------|-------------------------------------|-----|------|------|---------------|---|
| $V_{(BR)DSS}$ | Drain to Source Breakdown Voltage | 600 | 640 | - | V | $V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | 2.1 | 3 | 3.9 | | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | - | 0.1 | 1 | μA | $V_{DS} = 600\text{V}, V_{GS} = 0\text{V}, T_j = 25^\circ\text{C}$ |
| | | - | - | 100 | | $V_{DS} = 600\text{V}, V_{GS} = 0\text{V}, T_j = 150^\circ\text{C}$ |
| I_{GSS} | Gate Source Leakage Current | - | - | 100 | nA | $V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$ |
| $R_{DS(on)}$ | Drain to Source On-State Resistance | - | 0.23 | 0.25 | Ω | $V_{GS} = 10\text{V}, I_D = 7.5\text{A}, T_j = 25^\circ\text{C}$ |
| | | - | 0.59 | - | | $V_{GS} = 10\text{V}, I_D = 7.5\text{A}, T_j = 150^\circ\text{C}$ |
| R_{GS} | Gate Resistance | - | 4.7 | - | Ω | f = 1 MHz, open drain |

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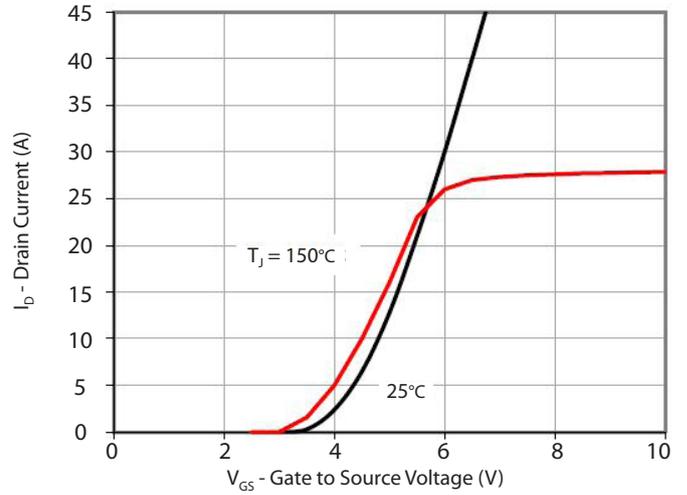
| Symbol | Parameter | Values | | | Unit | Conditions |
|------------------------------------|-------------------------------|--------|------|-----|---------------|---|
| | | Min | Typ | Max | | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | - | 1800 | - | pF | $V_{GS} = 0V, V_{DS} = 25V, f = 1 \text{ MHz}$ |
| C_{oss} | Output Capacitance | - | 900 | - | | |
| C_{rss} | Reverse Transfer Capacitance | - | 5 | - | | |
| g_{fs} | Transconductance | - | 15 | - | S | $V_{DS} = >2 \cdot I_D \cdot R_{DS}, I_D = 7.5A$ |
| $t_{d(on)}$ | Turn-on Delay Time | - | 39 | - | nS | $V_{DS} = 380V, V_{GS} = 10V, I_D = 15A, R_G = 4\Omega$ (External) |
| T_r | Rise Time | - | 10 | - | | |
| $t_{d(off)}$ | Turn-off Delay Time | - | 55 | - | | |
| t_f | Fall Time | - | 6 | - | | |
| Gate Charge Characteristics | | | | | | |
| Q_{gs} | Gate to Source Charge | - | 11 | - | nC | $V_{DS} = 480V, I_D = 15A, V_{GS} = 0 \text{ to } 10V$ |
| Q_{gd} | Gate to Drain Charge | - | 18 | - | | |
| Q_g | Gate Charge Total | - | 59 | - | | |
| $V_{plateau}$ | Gate Plateau Voltage | - | 5.5 | - | V | |
| Reverse Diode | | | | | | |
| V_{SD} | Diode Forward Voltage | - | 0.9 | 1.2 | V | $V_{GS} = 0V, I_S = I_F$ |
| t_{rr} | Reverse Recovery Time | - | 400 | - | ns | $V_{RR} = 480V, I_S = I_F, d_{IF}/d_t = 100 \text{ A}/\mu\text{S}$ |
| Q_{rr} | Reverse Recovery Charge | - | 6 | - | μC | |
| I_{rm} | Peak Reverse Recovery Current | - | 35 | - | A | |

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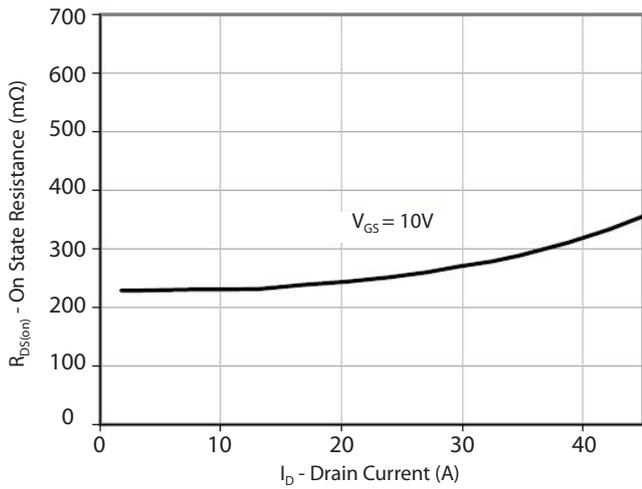
Output Characteristics



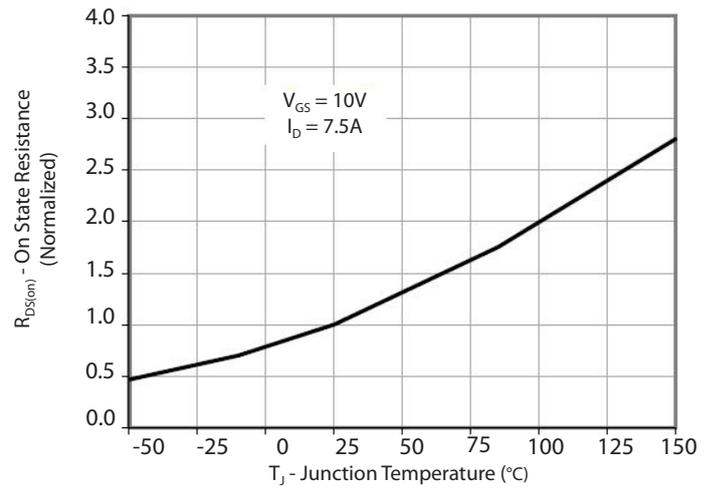
Transfer Characteristics



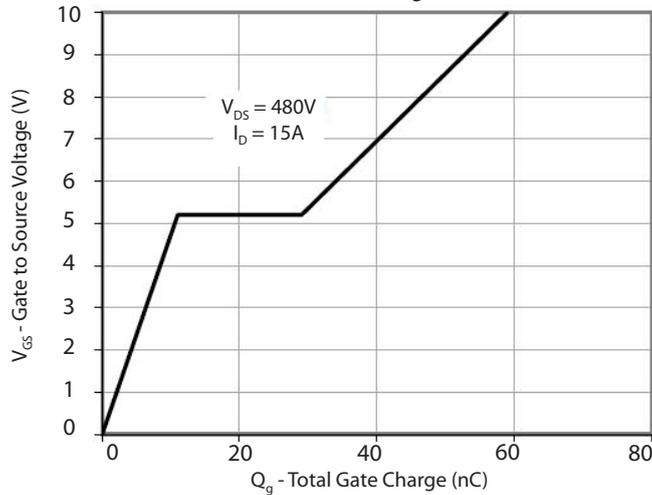
On State Resistance vs Drain Current



On Resistance vs Junction Temperature

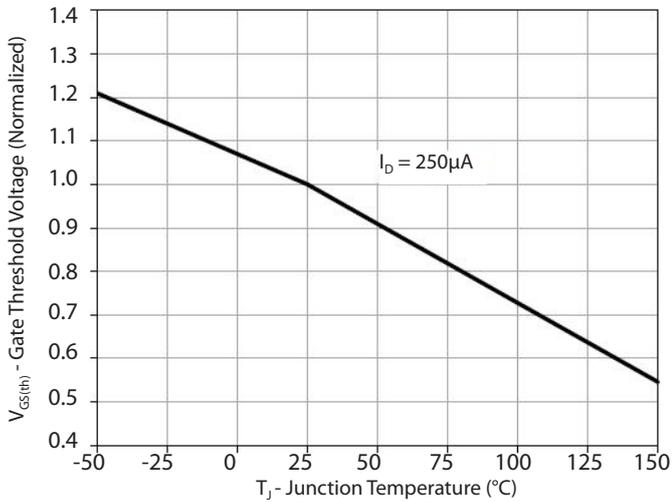


Gate Charge

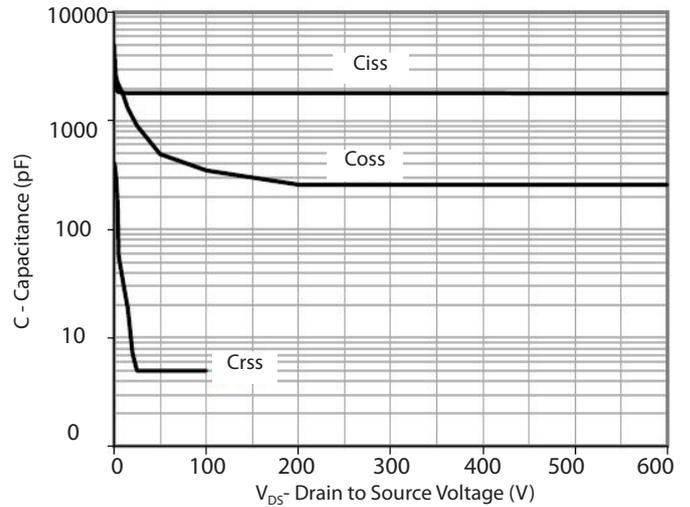


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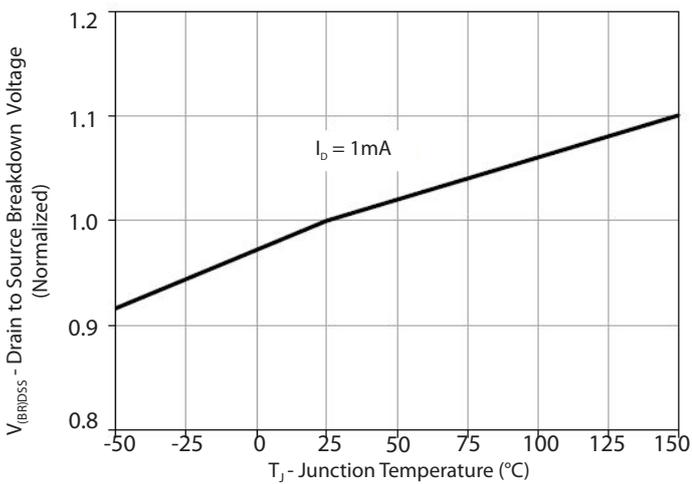
Gate Threshold Voltage vs. Junction Temperature



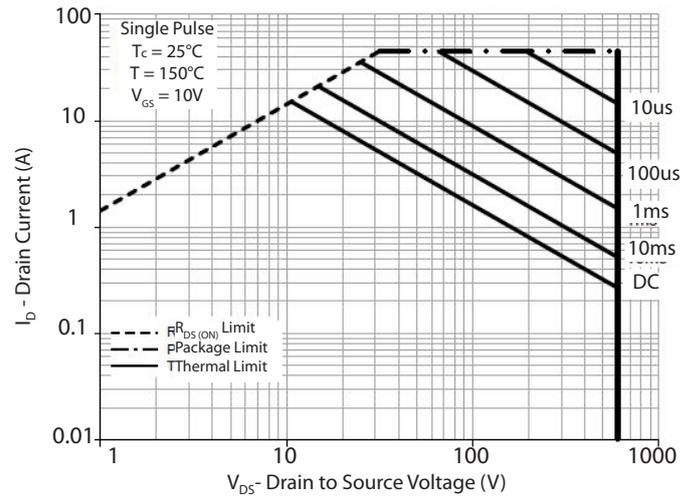
Capacitance



Drain to Source Breakdown Voltage vs. Junction Temperature



Maximum Rate Forward Biased Safe Operating Area



Transient Thermal Response - Junction to Case

